



42390.P6623

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TC 2800 MAIL ROOM

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Ma, et al.

Serial No.: 09/374,502

Filed: August 13, 1999

For: ISOLATION STRUCTURE
CONFIGURATIONS FOR
MODIFYING STRESSES IN
SEMICONDUCTOR DEVICES

Examiner: J. Fenty

Group Art Unit: 2815

Attorney Docket No.: 42390.P6623

CERTIFICATE OF MAILING

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Response
J. McMillan
11/12/02

RESPONSE AFTER FINAL REJECTION

Box AF
Hon. Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action mailed August 27, 2002, Applicants respectfully request that the Examiner enter and consider the following remarks: